DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

(Under 37 CFR § 1.63; includes reference to PCT International Applications)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention ENTITLED:

METHOD OF PREPARING CARBON NANOTUBE FROM LIQUID PHASED-CARBON SOURCE

the specification	on of which:				
	PCT Application No. P	Continuation or Continuation or Control CCT/KR2004/00074 S., and published as	ntinuation-in-Part or Div 5, filed <u>March 31, 2004</u> <u>WO 2004/087565 A</u> on		<u>4</u>
	by state that I have review laims, as amended by an			e-identified spec	ification,
	owledge the duty to disclose be material to patentabi				
application(s) f one country oth application for country other th	by claim foreign priority leads for patent or inventor's center than the United State patent or inventor's certical than the United States of the application(s) on which	ertificate or of any F of America listed b ficate or any PCT I America filed by m	CT International applice elow and have also identernational applications on the same subject m	ation(s) designati stified below any s designating at le	ing at least foreign east one
Prior Foreign/P	PCT Application(s) [list a	additional application	ons on separate page]:	Priority Cla	nimed:
Country (or South Korea		n <u>Number:</u> 0020858	Filed (Day/Month/Year) 02/04/2003	Yes X	<u>No</u>
I hereb	by claim the benefit unde	r 35 U.S.C. §119(e)	of any United States ap	plication listed b	elow:
(Applie	cation Number)	(Filing Date)			
I hereb or PCT interna	by claim the benefit unde ational application(s) desi	r Title 35, United S gnating the United	tates Code § 120 of any States of America that is	United States ap	plication(s) and, insof

I hereby claim the benefit under Title 35, United States Code § 120 of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

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Prior U.S. (or U.S.-designating PCT) Application(s) [list additional applications on separate page]:

U.S. Serial No.: Filed (Day/Month/Year) PCT Application No. Status (patented, pending, abandoned)

I hereby appoint Ronald R. Santucci, Registration No. 28,988, and Frommer Lawrence & Haug LLP, or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection therewith, and to insert the Serial Number of the application in the space provided above, and specify that all communications about the application are to be directed to the following correspondence address:

Ronald R. Santucci, Esq. c/o FROMMER LAWRENCE & HAUG LLP 745 Fifth Avenue New York, NY 10151

Direct all telephone calls to: (212) 588-0800 to the attention of: Ronald R. Santucci

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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